

Title (en)  
RFID device

Title (de)  
RFID-Vorrichtung

Title (fr)  
Dispositif d'identification à radio fréquence

Publication  
**EP 2259213 A3 20111005 (EN)**

Application  
**EP 10010109 A 20070131**

Priority  
• EP 07002102 A 20070131  
• JP 2006031720 A 20060208

Abstract (en)  
[origin: EP1818860A2] It is an object to provide a semiconductor device capable of transmitting and receiving data with a reader/writer and reducing breakdown or interference due to static electricity. A semiconductor device includes a semiconductor integrated circuit (112,114), a conductive layer serving as an antenna (151) that is connected to the semiconductor integrated circuit, and a substrate (111) interposing the semiconductor integrated circuit and the conductive layer, where at least one of a layer forming the semiconductor integrated circuit, a layer (142) covering the semiconductor integrated circuit, and the substrate (104) is formed from a conductive polymer. In accordance with the above structure, wireless communication with a reader/writer is possible, and breakdown or malfunction in the semiconductor integrated circuit due to static electricity is reduced.

IPC 8 full level  
**C09D 11/00** (2006.01); **C09K 3/16** (2006.01); **G03C 1/85** (2006.01); **G06K 19/077** (2006.01); **H01B 1/12** (2006.01); **H01L 51/00** (2006.01)

CPC (source: EP KR US)  
**B05B 1/3046** (2013.01 - KR); **B05B 12/002** (2013.01 - KR); **B05B 13/0278** (2013.01 - KR); **G06K 19/07749** (2013.01 - EP US); **H01L 24/97** (2013.01 - EP US); **H01L 2224/16237** (2013.01 - EP US); **H01L 2924/01006** (2013.01 - EP US); **H01L 2924/0101** (2013.01 - EP US); **H01L 2924/01013** (2013.01 - EP US); **H01L 2924/01018** (2013.01 - EP US); **H01L 2924/01023** (2013.01 - EP US); **H01L 2924/01024** (2013.01 - EP US); **H01L 2924/01027** (2013.01 - EP US); **H01L 2924/01029** (2013.01 - EP US); **H01L 2924/0103** (2013.01 - EP US); **H01L 2924/01033** (2013.01 - EP US); **H01L 2924/0104** (2013.01 - EP US); **H01L 2924/01041** (2013.01 - EP US); **H01L 2924/01042** (2013.01 - EP US); **H01L 2924/01044** (2013.01 - EP US); **H01L 2924/01045** (2013.01 - EP US); **H01L 2924/01046** (2013.01 - EP US); **H01L 2924/01047** (2013.01 - EP US); **H01L 2924/01056** (2013.01 - EP US); **H01L 2924/01058** (2013.01 - EP US); **H01L 2924/0106** (2013.01 - EP US); **H01L 2924/01067** (2013.01 - EP US); **H01L 2924/01068** (2013.01 - EP US); **H01L 2924/01072** (2013.01 - EP US); **H01L 2924/01073** (2013.01 - EP US); **H01L 2924/01074** (2013.01 - EP US); **H01L 2924/01076** (2013.01 - EP US); **H01L 2924/01077** (2013.01 - EP US); **H01L 2924/01078** (2013.01 - EP US); **H01L 2924/01079** (2013.01 - EP US); **H01L 2924/07811** (2013.01 - EP US); **H01L 2924/10253** (2013.01 - EP US); **H01L 2924/10329** (2013.01 - EP US); **H01L 2924/12042** (2013.01 - EP US); **H01L 2924/12044** (2013.01 - EP US); **H01L 2924/13091** (2013.01 - EP US); **H01L 2924/14** (2013.01 - EP US); **H01L 2924/15788** (2013.01 - EP US); **H01L 2924/19041** (2013.01 - EP US); **H01L 2924/19043** (2013.01 - EP US)

Citation (search report)  
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Designated contracting state (EPC)  
DE FI FR GB NL

DOCDB simple family (publication)  
**EP 1818860 A2 20070815**; **EP 1818860 A3 20070829**; **EP 1818860 B1 20110330**; DE 602007013478 D1 20110512;  
EP 2259213 A2 20101208; EP 2259213 A3 20111005; EP 2259213 B1 20151223; KR 101402104 B1 20140530; KR 20070080829 A 20070813;  
US 2007181875 A1 20070809; US 8138614 B2 20120320

DOCDB simple family (application)  
**EP 07002102 A 20070131**; DE 602007013478 T 20070131; EP 10010109 A 20070131; KR 20070011384 A 20070205; US 70208507 A 20070205